

1A, 600V - 1000V Surface Mount Rectifiers

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- Low leakage current
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21







HALOGEN

FREE

SMAF



Case: SMAF

Molding compound: UL flammability classification rating 94V-0

MSL1: per J-STD-020

Packing code with suffix "G" means green compound (halogen-free) **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test **Polarity:** Indicated by cathode band **Weight:** 35mg (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted)					
PARAMETER	SYMBOL	S1JF	S1KF	S1MF	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	600	800	1000	V
Maximum RMS voltage	V_{RMS}	420	560	700	V
Maximum DC blocking voltage	V _{DC}	600	800	1000	V
Maximum average forward rectified current	I _{F(AV)}	1			Α
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30		А	
Maximum instantaneous forward voltage (Note 1) @ 1 A	V _F	1.1		V	
Maximum reverse current @ rated V_R T_J =25°C T_J =125°C	I _R	5 50		μA	
Typical reverse recovery time (Note 2)	t _{rr}	1.8			μs
Typical junction capacitance (Note 3)	C _J		6		pF
Typical thermal resistance	$R_{ heta JL} \ R_{ heta JA}$	25 70		°C/W	
Operating junction temperature range	T _J		- 55 to +150		°C
Storage temperature range	T _{STG}		- 55 to +150		°C

Note 1: Pulse test with PW=300µs, 1% duty cycle

Note 2: Test conditions: I_F=0.5A, I_R=1.0A, I_{RR}=0.25A

Note 3: Measured at 1 MHz and applied reverse voltage of 4.0V DC.



ORDERING INFORMATION					
PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING	
S1xF	R3	G	SMAF	3,000 / 7" Plastic reel	
(Note 1, 2)	R2	G	SMAF	10,000 / 13" Paper reel	

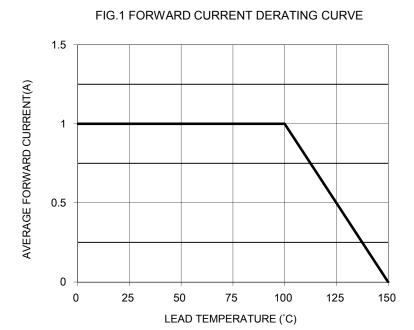
Note 1: "x" defines voltage from 600V (S1JF) to 1000V (S1MF)

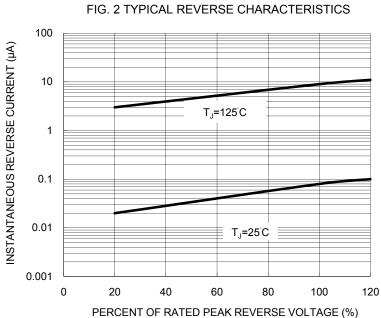
Note 2: Whole series with green compound

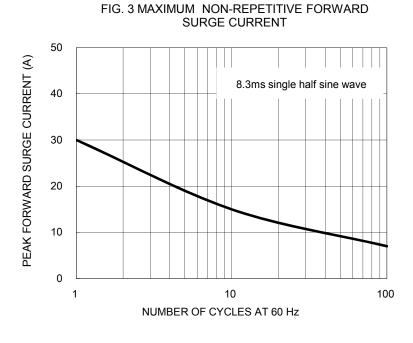
EXAMPLE				
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
S1JF R3G	S1JF	R3	G	Green compound

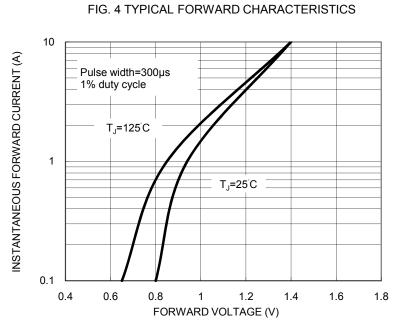
RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)







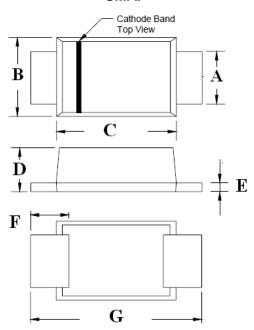


Document Number: DS_D1511004



PACKAGE OUTLINE DIMENSIONS

SMAF



DIM.	Unit (mm)		Unit (inch)		
DIW.	Min	Max	Min	Max	
Α	1.25	1.60	0.049	0.063	
В	2.40	2.80	0.094	0.110	
С	3.30	4.30	0.130	0.169	
D	0.90	1.10	0.035	0.043	
Е	0.10	0.25	0.004	0.010	
F	0.70	1.20	0.028	0.047	
G	4.40	5.20	0.173	0.205	

MARKING DIAGRAM



P/N = Specific Device Code

G = Green compound Code

YW = Date Code

F = Factory Code



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Document Number: DS_D1511004 Version: A15